

600V, 15A, Trench FS II Fast IGBT

General Description

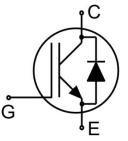
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology offering
- Very low V_{CE(sat)}
- High speed switching
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

- Air Condition
- Inverters
- Motor drives



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking		
NCE15TD60B	TO-220	NCE15TD60B		



TO-220

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
V _{CES}	Collector-Emitter Voltage	600	V
V _{GES}	Gate- Emitter Voltage	±30	V
	Collector Current	30	А
Ic	Collector Current @T _C = 100 °C	15	Α
I _{Cpuls}	Pulsed Collector Current, t _p limited by T _{jmax}	45	Α
-	turn off safe operating area,V _{CE} =600V,T _j =175°C	45	А
l _F	Diode Continuous Forward Current @Tc = 100 °C	15	А
I _{FM}	Diode Maximum Forward Current	45	Α
Б	Power Dissipation @ T _C = 25°C	105	W
P _D	Power Dissipation @T _C = 100 °C	52.5	W
T _J ,T _{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C
TL	Maximum Temperature for Soldering	260	°C
t _{sc}	Short circuit withstand time V _{GE} =15.0V, V _{CC} \leq 400V, Allowed number of short circuits<1000Time between short circuits: \geq 1.0s,T _j \leq 150°C	5	us



Thermal Characteristic

Symbol	Parameter	Value	Units
R _{θJC}	Thermal Resistance, Junction to case for IGBT	1.42	°C/W
R _{0JC}	Thermal Resistance, Junction to case for Diode	2.48	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	62	°C/W

Electrical Characteristics (T_C=25°C unless otherwise noted)

0	Barrantan	Conditions		Rating			
Symbol	Parameter			Min.	Тур.	Max.	Units
Static Chara	cteristics						
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V	,I _{CE} =1mA	600			V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V	V _{CE} =600V			5	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30	V,V _{CE} =0V			200	nA
I _{GES(R)}	Gate to Emitter Reverse Leakage	V _{GE} =-30	V,V _{CE} =0V			200	nA
V	Collector Emitter Seturation Voltage	Ic=15A	T _j =25°C		1.7	1.9	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	V _{GE} =15V	T _j =175°C		1.9		V
$V_{GE(th)}$	Gate Threshold Voltage	I _C =1mA	,V _{CE} =V _{GE}	4.0		6.0	V
Dynamic Ch	aracteristics						
Cies	Input Capacitance) / OF)	/) / 0) /		1635		
Coes	Output Capacitance	V _{CE} =25V,V _{GE} =0V, f=1MHz			50		pF
C _{res}	Reverse Transfer Capacitance				30		
Qg	Total Gate Charge	V _{cc} =480V, I _c =15A V _{GE} =15V			63		nC
Q_{ge}	Gate to Emitter Charge				15		
Q _{gc}	Gate to Collector Charge	V GE	-10 V		26		1
I _{C(SC)}	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	V _{GE} =15V,V _{CC} ≤400V, t _{SC} ≤5us,Tj≤150°C			82		А
Switching C	haracteristics						
$t_{\text{d}(\text{ON})}$	Turn-on Delay Time				16		
t _r	Rise Time	V_{CC} =400V, I_{C} =15A V_{GE} =0/15V, R_{g} =5 Ω Inductive Load			12		no
$t_{\text{d}(OFF)}$	Turn-Off Delay Time				124		ns
t _f	Fall Time				12		
E _{on}	Turn-On Switching Loss				0.25		
E _{off}	Turn-Off Switching Loss				0.12		mJ
E _{ts}	Total Switching Loss				0.37		

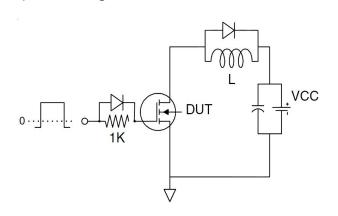
Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified)

Symbol	Parameter	Conditions	Rating			l laita
Symbol			Min.	Тур.	Max.	Units
V _{FM}	Diode Forward Voltage	I _F =15A		1.75	2.40	V
Trr	Reverse Recovery Time	- I₅=15A, - di/dt=200A/us		170		ns
I _{RRM}	Diode Peak Reverse Recovery Current			6.5		А
Qrr	Reverse Recovery Charge	ui/ut-200A/us		0.6		uC
Pulse width t _p ≤380μs,δ≤2%						

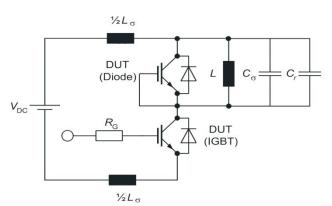


Test Circuit

1) Gate Charge Test Circuit

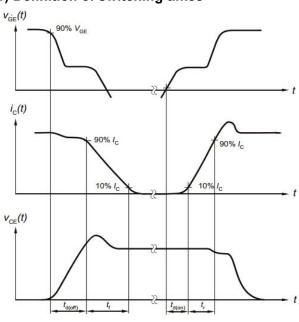


2) Switch Time Test Circuit

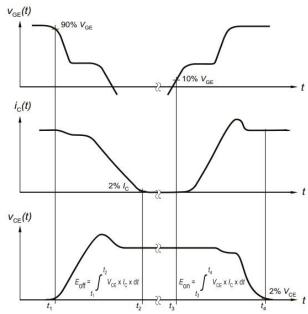


Switching characteristics

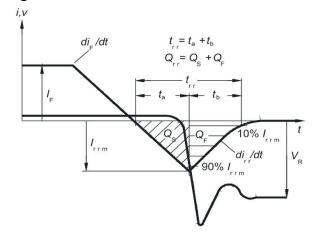
1) Definition of switching times



2) Definition of switching losses



3) Definition of diode switching characteristics





Typical Electrical and Thermal Characteristics



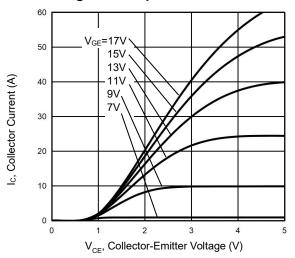


Figure 3 V_{CEsat} vs. Case Temperature

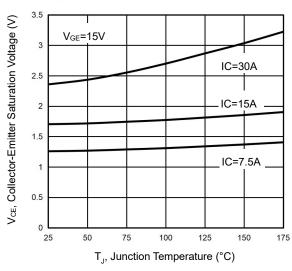


Figure 5 Capacitance Characteristics

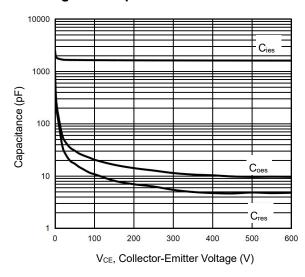
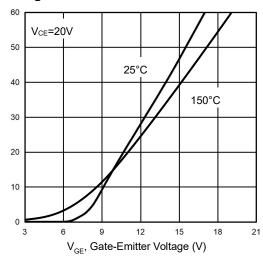


Figure 2 Transfer Characteristics



Ic, Collector Current (A)

Figure 4 Saturation Voltage vs. V_{GE}

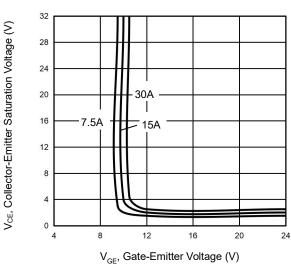
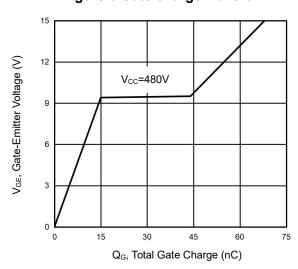


Figure 6 Gate charge waveform





Typical Electrical and Thermal Characteristics

Figure 7 Gate-emitter Threshold Voltage as a **Function of Junction Temperature**

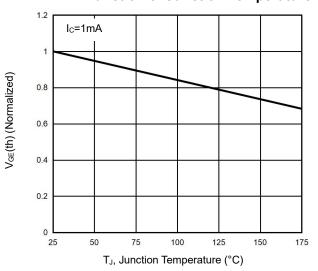


Figure 9 Typical Switching Times as a **Function of Junction Temperature**

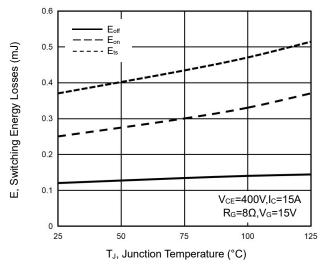
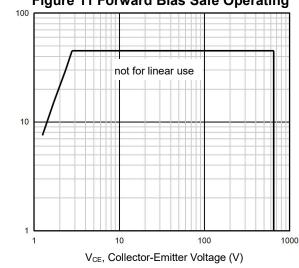


Figure 11 Forward Bias Safe Operating



Ic, Collector Current (A)

Figure 8 Typical Switching Times as a **Function of Gate Resistor**

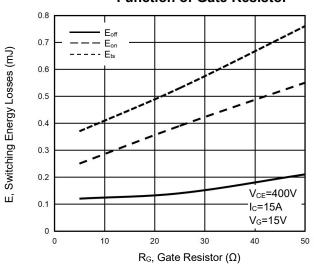


Figure 10 Power Dissipation as a **Function of Case Temperature**

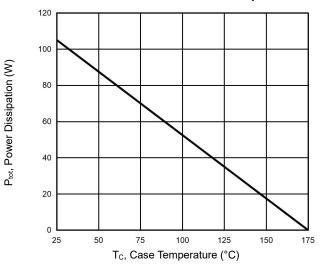
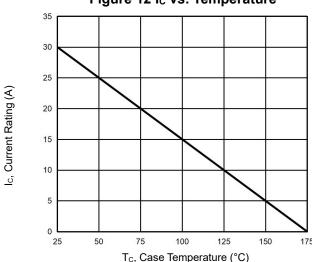


Figure 12 I_C vs. Temperature





Typical Electrical and Thermal Characteristics

Figure 13 Forward Characteristics

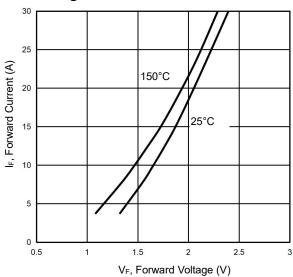
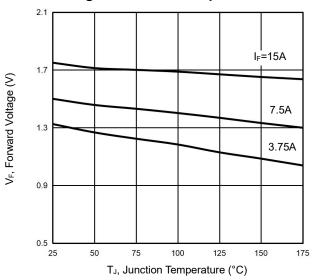
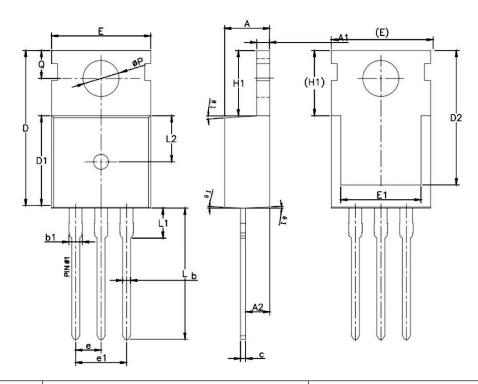


Figure 14 V_F vs. Temperature





TO-220-P Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches		
- Cymbol	Min.	Max.	Min.	Max.	
А	4.40	4.60	0.17	0.18	
A1	1.27	1.33	0.05	0.05	
A2	2.30	2.50	0.09	0.10	
b	0.70	0.90	0.03	0.04	
b1		1.40		0.06	
С	0.45	0.60	0.01	0.02	
D	15.30	16.10	0.60	0.63	
D1	9.10	9.30	0.36	0.37	
D2	13.10	13.70	0.52	0.54	
Е	9.70	10.20	0.38	0.40	
E1	7.80	8.20	0.31	0.32	
е	2.54	IBSC	0.10)BSC	
e1	5.08BSC		0.20BSC		
H1	6.30	6.70	0.25	0.26	
L	12.78	13.38	0.50	0.53	
L1		3.50		0.14	
L2	4.60REF		0.18REF		
ФР	3.55	3.65	0.13	0.14	
Q	2.73	2.87	0.10	0.11	
Θ1	1°	5°	0.04	0.20	





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